

Appln No. 10/760,206
Amdt. Dated January 9, 2005
Response to Office Action of November 14, 2005

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Amendment to the Specification:

The paragraph beginning at Page 9, lines 1 to 2, are to be amended as follows:

The ink jet printhead chip 52 (see Fig. 6) includes a silicon wafer substrate 8015.
0.35 Micron 1 P4M 12 volt CMOS microprocessing circuitry is positioned on the silicon
wafer substrate 8015.